Docket No.:

DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby dec	lare that:		
My residence, post office and citizenship	are as stated below next to m	y name,	
I believe I am the original, first and sole names are listed below) of the subject m SYSTEM FOR SERVING PACKE specification of which	atter claimed and for which a	patent is sought on the inv	vention entitled METHOD AND
[X] is attached hereto [] was filed amended on	on as A	pplication Serial No (if applicable)	and was
I hereby state that I have reviewed and amended by any amendment referred to a		the above identified speci	ification, including the claims, as
I acknowledge the duty to disclose infor Code of Federal Regulations, Section 1.5		e to be material to patental	bility in accordance with Title 37,
I hereby claim foreign priority benefits to certificate, or 365(a) of any PCT internal America, listed below and have also iden or of any PCT international application h	ational application which des tified below, by checking the	ignated at least one count box, any foreign application	ry other than the United States of a for patent or inventor's certificate.
Prior Foreign Application(s): Number	Country	_	Filing Date Dav/Year
67014/2000	Korea	Novem	ber 11, 2000
I hereby claim the benefit under 35 U.S.C Application Number(s):	C.119(e) of any United States <u>Filing Date(Mo</u>	provisional application(s) li nth/Day/Year)	isted below.
I hereby claim the benefit under 35, U. S designating the United States of America not disclosed in the prior United States of 112, I acknowledge the duty to disclose available between the filing date of the prior United States of the prior United States of 112, I acknowledge the duty to disclose available between the filing date of the prior United States of America and United States of States of United States of Uni	 a, listed below and, insofar as r PCT international applications information which is material 	the subject matter of each in the manner provided by all to patentability as define	of the claims of this application is y the first paragraph of 35 U. S. C. ed in 37 CFR 1.56 which became
Prior U.S. Application or PCT Parent Number	Filing Date(Month/Day	<u>(Year)</u> <u>Pare</u>	nt Patent Number (if applicable)
I hereby declare that all statements mad belief are believed to be true; and further	de herein of my own knowleder that these statements were a	ge are true and that all stanate with the knowledge to	atements made on information and hat willful false statements and the

like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that

such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, Rene A. Vasquez, Registration No. 38,647; Stuart I. Smith, Registration No. 42,159; Carol L. Druzbick, Registration No. 40,287; Anthony H.Nourse, Registration No. 46,121; and Margaret A. Burke, Registration No. 34,474, all of

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with full power of substitution and revocation, to prosecute this application and to Office connected therewith, and all future correspondence should be addressed to	o transact all business in the Patent and Trademark them.
*************************************	**************************************
Full name of sole or first inventor: Byung Keun LIM	
Inventor's signature:	Date: Nov. 6, 200
Residence: Kyoungki-do	
Citizenship: Republic of Korea	all demonstrate value and an address of
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**************************************	**************************************
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Inventor's signature:	Date:
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***************************************	**********************
Full name of joint inventor(s):	
Inventor's signature:	Date:
Residence:	
Citizenship:	
Post Office Address:	
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Full name of joint inventor(s):	
Inventor's signature:	Date:
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